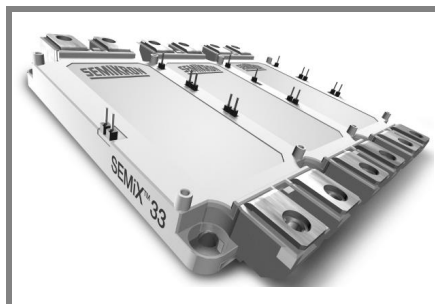


SEMiX 453GD12T4c



SEMiX® 33c

Trench IGBT Modules

SEMiX 453GD12T4c

Target Data

Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability

Typical Applications

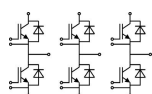
- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$

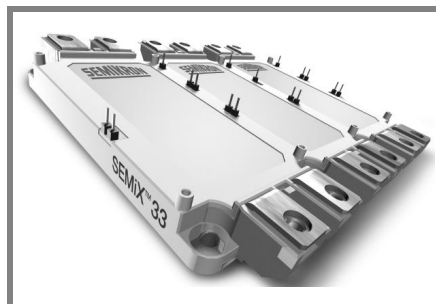
Absolute Maximum Ratings		T _{case} = 25°C, unless otherwise specified		
Symbol	Conditions	Values	Units	
IGBT				
V _{CES}	T _j = 25 °C	1200	V	
I _C	T _j = 175 °C	T _c = 25 °C	685	A
		T _c = 80 °C	525	A
I _{CRM}	I _{CRM} =3xI _{Cnom}	1350	A	
V _{GES}		± 20	V	
t _{psc}	V _{CC} = 600 V; V _{GE} ≤ 20 V; T _j = 150 °C V _{CES} < 1200 V	10	µs	
Inverse Diode				
I _F	T _j = 175 °C	T _c = 25 °C	545	A
		T _c = 80 °C	405	A
I _{FRM}	I _{FRM} =3xI _{Fnom}	1350	A	
Module				
I _{t(RMS)}		600	A	
T _{vj}		- 40 ... + 175	°C	
T _{stg}		- 40 ... + 125	°C	
V _{isol}	AC, 1 min.	4000	V	

Characteristics		$T_{\text{case}} = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{\text{GE(th)}}$	$V_{\text{GE}} = V_{\text{CE}}, I_{\text{C}} = 18\text{ mA}$	5	5,8	6,5	V
I_{CES}	$V_{\text{GE}} = 0\text{ V}, V_{\text{CE}} = V_{\text{CES}} \quad T_j = 25^\circ\text{C}$				mA
V_{CE0}	$T_j = 25^\circ\text{C}$		0,8	0,9	V
			0,7	0,8	V
r_{CE}	$V_{\text{GE}} = 15\text{ V} \quad T_j = 25^\circ\text{C}$		2,2	2,4	m Ω
			3,3	3,6	m Ω
$V_{\text{CE(sat)}}$	$I_{\text{Cnom}} = 450\text{ A}, V_{\text{GE}} = 15\text{ V} \quad T_j = 25^\circ\text{C}_{\text{chiplev.}}$		1,8	2	V
			2,2	2,4	V
C_{ies}	$V_{\text{CE}} = 25, V_{\text{GE}} = 0\text{ V} \quad f = 1\text{ MHz}$		27,9		nF
C_{oes}			1,7		nF
C_{res}			1,5		nF
Q_{G}	$V_{\text{GE}} = -8 \dots +15\text{ V}$		2600		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		1,7		Ω
$t_{\text{d(on)}}$	$R_{\text{Gon}} = 1,9\ \Omega \quad V_{\text{CC}} = 600\text{ V}$ $di/dt = 4000\text{ A}/\mu\text{s} \quad I_{\text{Cnom}} = 450\text{ A}$ $T_j = 150^\circ\text{C}$		305		ns
t_{r}			80		ns
E_{on}			45		mJ
$t_{\text{d(off)}}$			535		ns
t_{f}			100		ns
E_{off}			50		mJ
$R_{\text{th(j-c)}}$	per IGBT			0,065	K/W



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- High short circuit capability

Typical Applications

- AC inverter drives
- UPS
- Electronic Welding

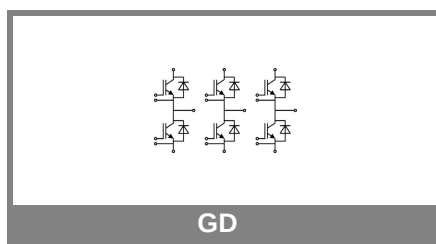
Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$

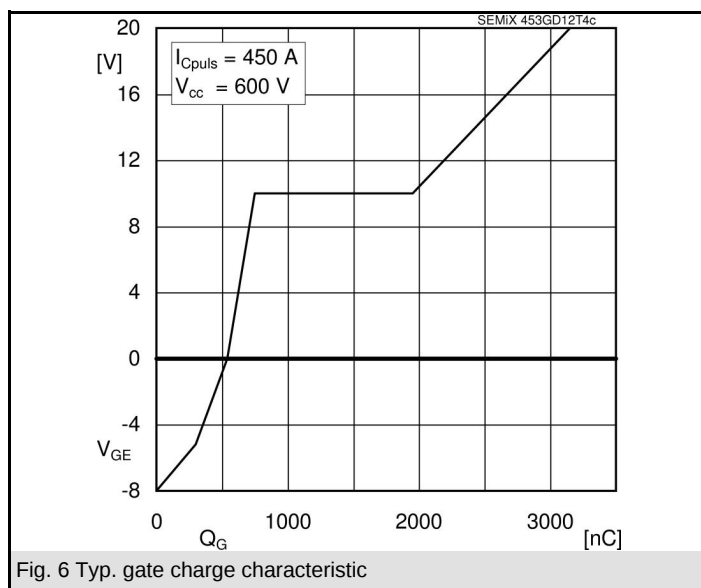
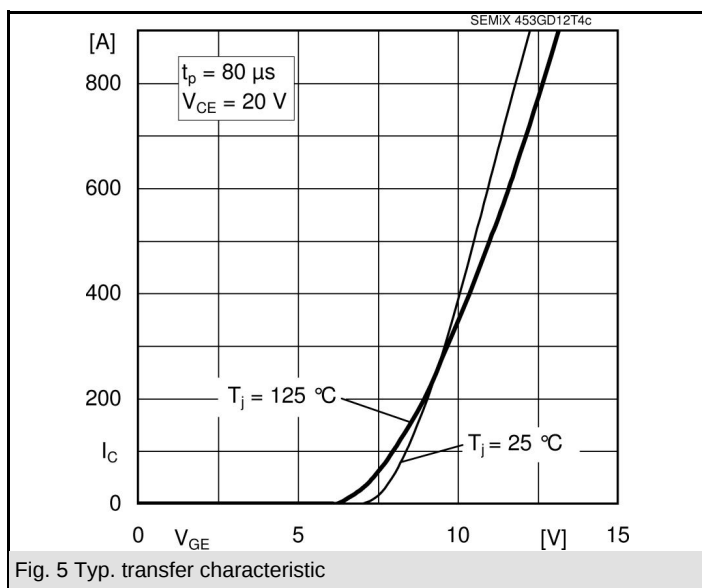
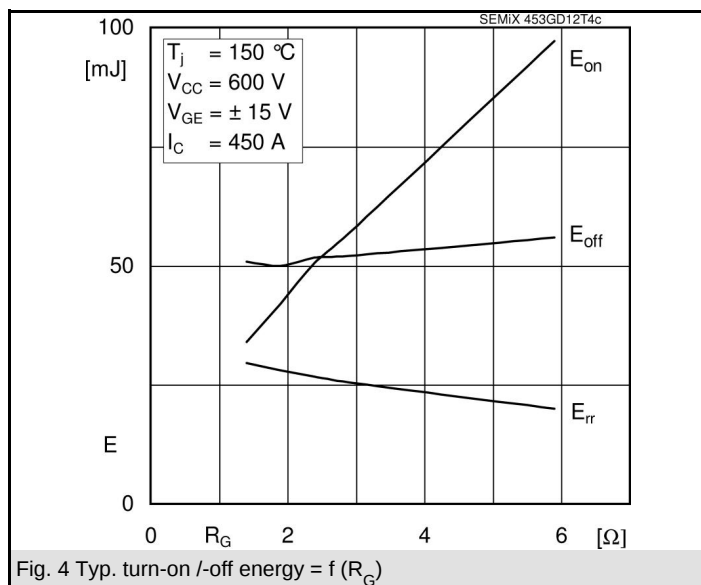
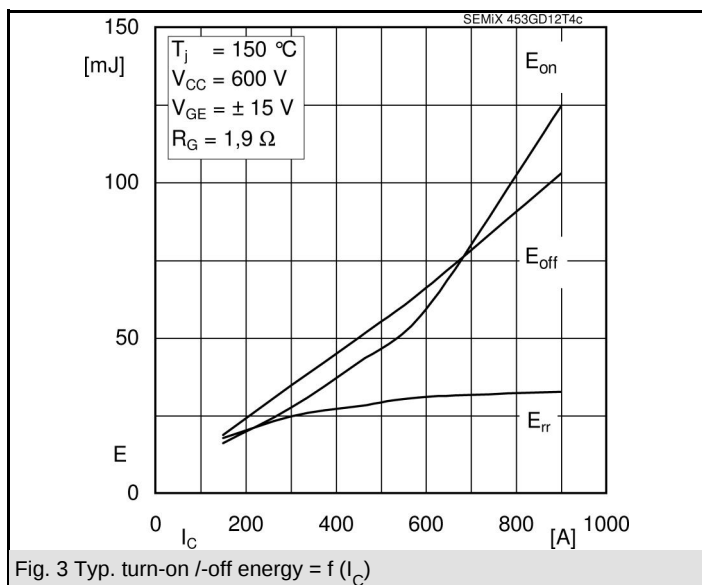
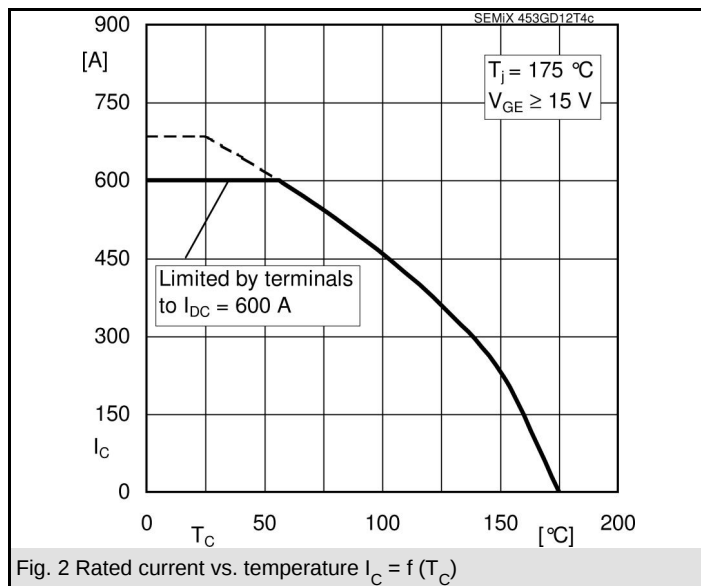
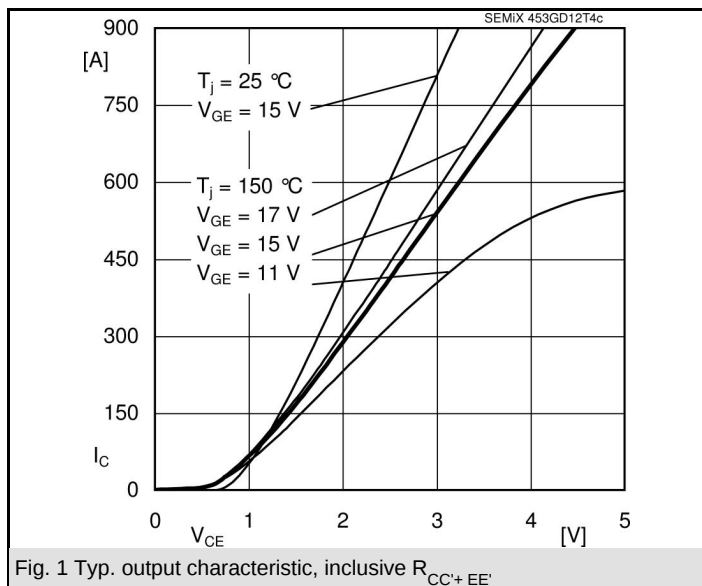
Characteristics						
Symbol	Conditions		min.	typ.	max.	Units
Inverse Diode						
V _F = V _{EC}	I _{Fnom} = 450 A; V _{GE} = 0 V	T _j = 25 °C _{chiplev.}		2,15	2,45	V
		T _j = 150 °C _{chiplev.}		2,05	2,4	V
V _{F0}		T _j = 25 °C		1,3	1,5	V
		T _j = 150 °C		0,9	1,1	V
r _F		T _j = 25 °C		1,9	2,1	mΩ
		T _j = 150 °C		2,6	2,9	mΩ
I _{RRM}	I _{Fnom} = 450 A	T _j = 150 °C		350		A
Q _{rr}	di/dt = 5000 A/μs			70		μC
E _{rr}	V _{GE} = -15 V; V _{CC} = 600 V			28		mJ
R _{th(j-c)D}	per diode				0,11	K/W
Module						
L _{CE}				20		nH
R _{CC'+EE'}	res., terminal-chip	T _{case} = 25 °C		0,7		mΩ
		T _{case} = 125 °C		1		mΩ
R _{th(c-s)}	per module			0,014		K/W
M _s	to heat sink (M5)		3		5	Nm
M _t	to terminals (M6)		2,5		5	Nm
w					900	g
Temperature sensor						
R ₁₀₀	T _c =100°C (R ₂₅ =5 kΩ)			0,493±5%		kΩ
B _{100/125}	R(T)=R ₁₀₀ exp[B _{100/125} (1/T-1/T ₁₀₀)]; T[K]			3550±2%		K

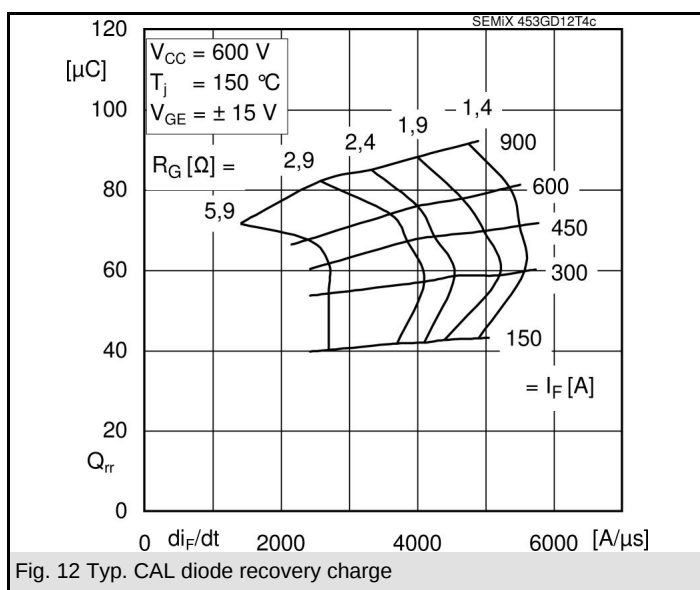
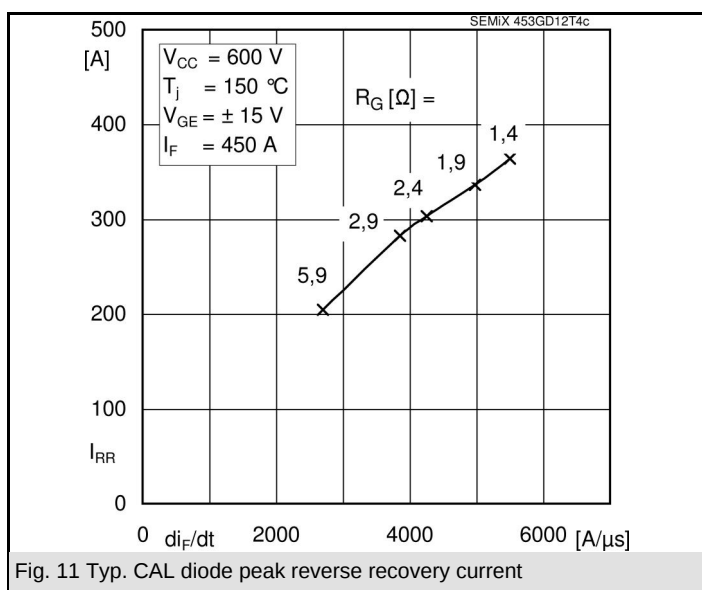
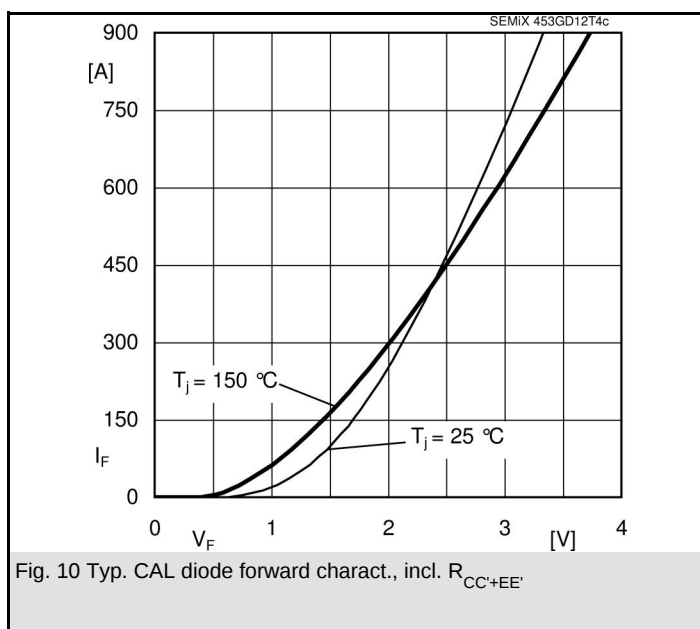
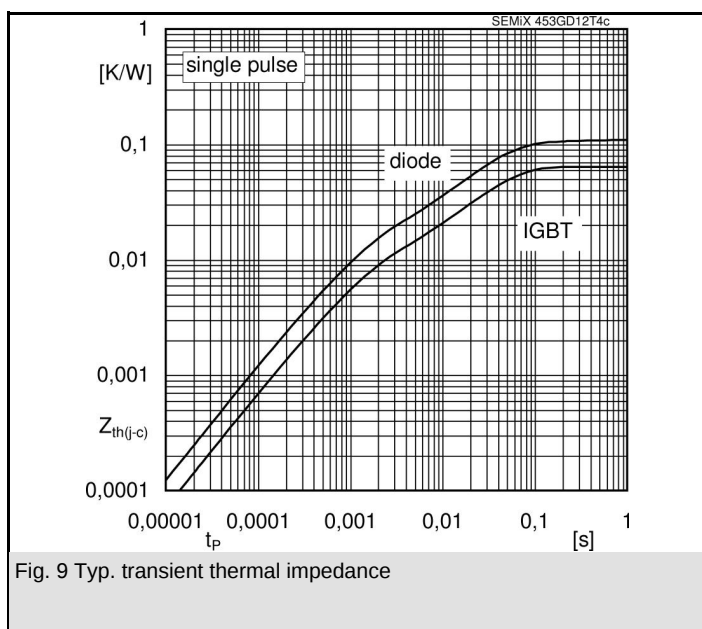
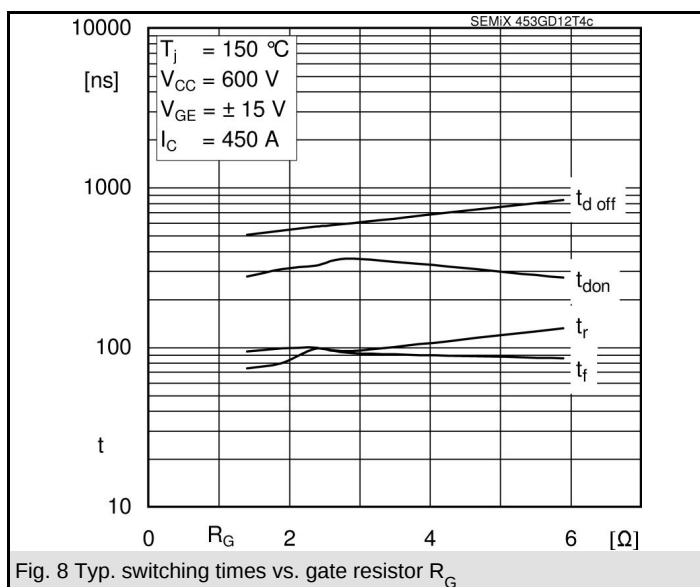
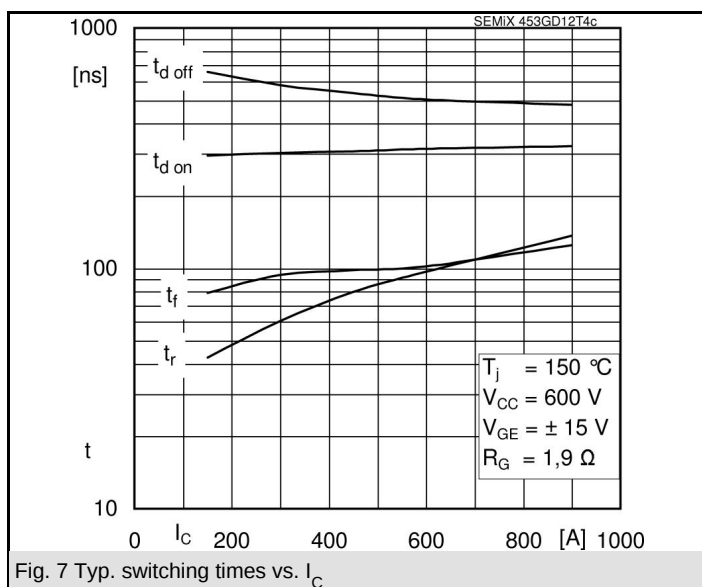
This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

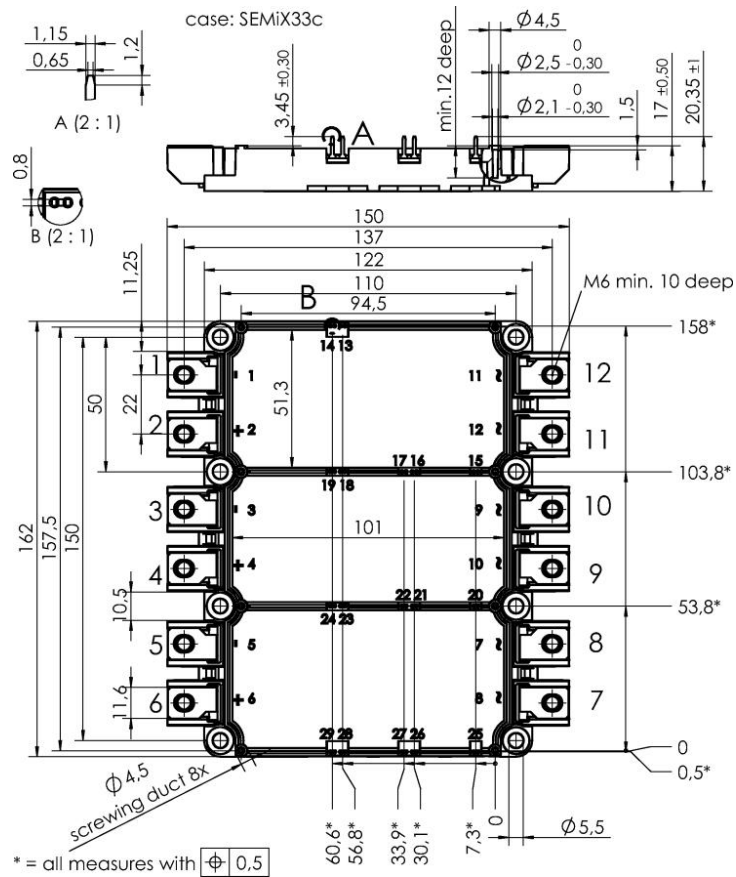


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SEMiX 453GD12T4c



Case SEMiX 33c

